

N0Y03S59

♦Outline(L*W*H): 3.5*2.8*1.9 mm

◆Good thermal dissipation & optical uniformity



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Features

- Forward current: \(\preceq\)0mA
- Typical view angle 50% Iv: 120°
- RoHS and REACH-compliant
- Lens color: water transparent
- Qualified according to JEDEC moisturevity
 Level 2a
- ESD level 2kV(HBM)

Applications

- Indoor lighting applications
- Flat backlight for LCD. Switch and symbol
- Indicator and backlighting for all consumer electronics
- Others applications





■ Product Code Method

1)	2	3	4	(5)
Process Type	Category	LED Type	Lead Frame Size	Dice wavelength &luminous rank
1 : Normal Process	S: SMD LED	C: PLCC top view D: PLCC side view	3528: 3.5* 2.8mm	Yxxx: yellow

6	7	8	9
Lap Polarity	Cap Color	PCB Module Code	Flow Code
0: non-common anode and non-common cathode	C: water transparent	E: Article Mode	01: no expression above meaning for company

■ Maximum Rating(Ta=25°C)

Characteristics	Symbol	Rating	Unit
DC Forward Current	I_{F}	30	mA
Pulse Forward Current*3	$ m I_{PF}$	100	mA
Reverse Current	V_R	10	V
Junction Temperature	T_{J}	110	°C
Operating Temperature Range	T_{OP}	-40-85	°C
Storage Temperature Range	$T_{ m STG}$	-40-100	°C
Soldering Temperature*4	T_{SD}	260	°C

Notes 1: There is no maximum or typical voltage parameter

- 2: For other ambient, limited setting of current will be depended on de-rating curves.
- 3: Duty 1/10, pulse width 0.1ms
- 4: The maximum of soldering time is 5 seconds in T_{SD}

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■ Typical Product Characteristics(Ta=25°C)

Characteristics Symbol Unit **Test condition** Min. Typ. Max. V Forward Voltage V_{F} 1.7 2.0 2.5 $I_F=20mA$ **Luminous Intensity** Iv120 210 mcd $I_F=20mA$ Dominant Wavelength λd 585 597 nm $I_F=20mA$ Reverse Current $V_R = 10V$ I_R 10 μΑ View Angle $2\theta_{1/2}$ 120 deg $I_F=20mA$

Notes: 1. Measurement errors:

Forward Voltage: ±0.1V, Luminous Intensity: ±10% Iv, Dominant Wavelength: ±1.0nm

2. Electrical-Optical Characteristics (Ta=25°C)

■ Range of Bins

1).Forward Voltage (I_F=20mA)

Bin Code	Min. V _F (V)	Max. V _F (V)		
A	1.7	1.8		
В	1.8	1.9		
C	1.9	2.0		
D	2.0	2.1		
Е	2.1	2.2		
F	2.2	2.3		
G	2.3	2.4		
Н	2.4	2.5		

2).Luminous Intensity (I_F=20mA)

Bin Code	Min. Iv(mcd)	Max. Iv(mcd)
7	120	160
8	160	210
9	210	270
10	270	350

3).Dominant Wavelength (I_F=20mA)

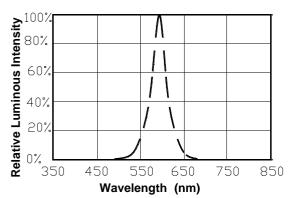
Bin Code	Min. λd(nm)	Max. λd(nm)
С	585	588
D	588	591
Е	591	594
F	594	597

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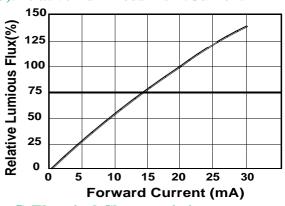


■ Electrical-Optical Characteristics

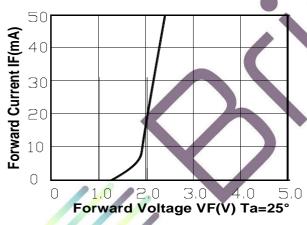
1). Relative Spectral Distribution



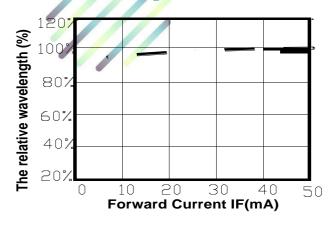
3). Relative Luminous Flux . Current



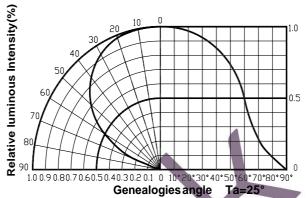
5). Electrical Characteristics



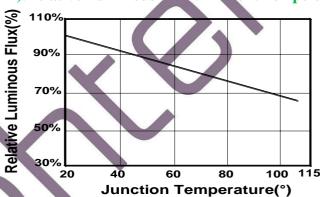
7). Relative Wavelength and current



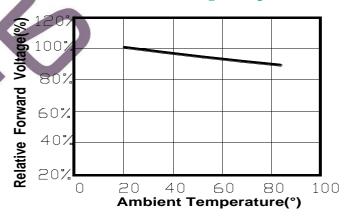
2). Typical Spatial Distribution



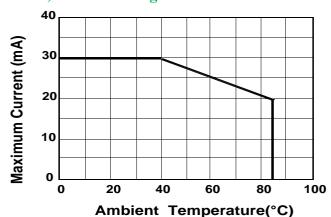
4). Relative Luminous Elux . Ambient Temperature



.Relative Forward Voltage Temperature

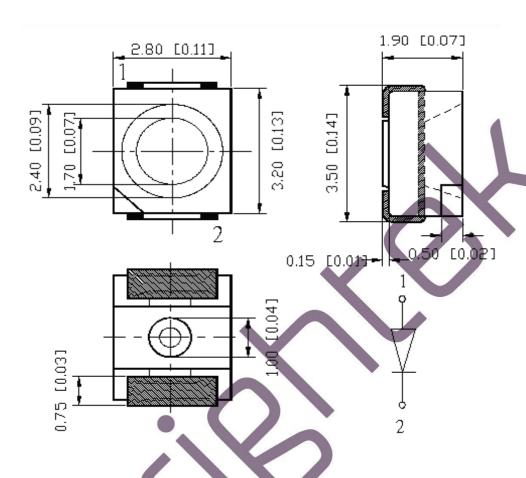


8). Thermal Design

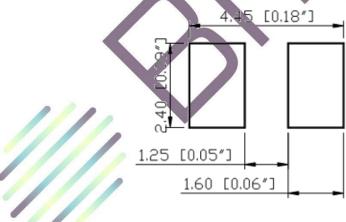




Dimensions



Recommend Pad layout



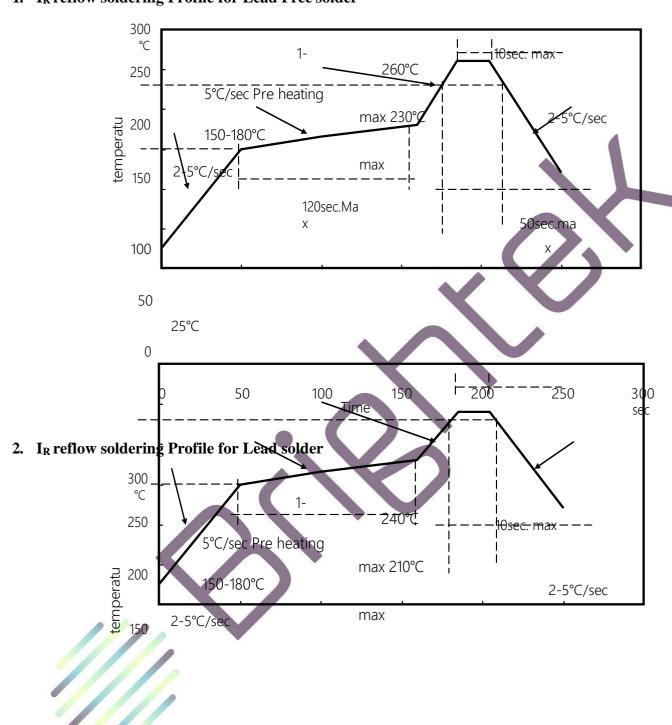
Notes: 1. All dimensions are in millimeters (inches)

- 2. Tolerance is $\pm 0.1~(\pm 0.004")$ mm unless otherwise noted
- 3. Specifications are subject to change without notice.



Reflow Profile

1. I_R reflow soldering Profile for Lead Free solder



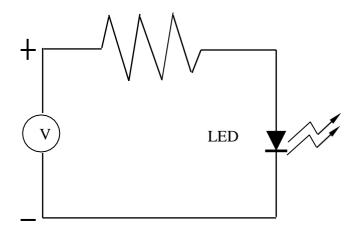
Notes:

- 1. We recommend the reflow temperature $240^{\circ}\text{C}(\pm 5^{\circ}\text{C})$.the maximum soldering temperature should be limited to 260°C .
- 2. Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall be less than 3 times.



■ Test Circuit and Handling Precautions

1. Test Circuit



2. Handling Precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C}(41^{\circ}\text{F} \sim 86^{\circ}\text{F})$

2). Shelf life in sealed bag: 12 month at 5°C~30°C and 60% R.H. after the package is Opened, the products should be used within four week or they should be keeping to stored at ≦20%R.H. with ziplock sealed.

2.3. Baking

It is recommended to baking before soldering when the pack is unsealed after 24hrs.

The Conditions are as followings:

1). $.60\pm3$ °C X 6hrs and 5%RH, for reel

2). $.125\pm3^{\circ}$ C X 2hrs, for single LED

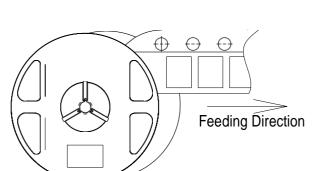
It shall be normal to see slight color fading of carrier (light yellow) after baking in process



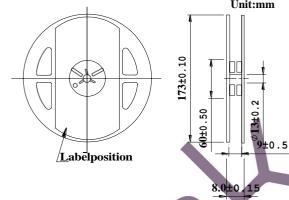
Packing

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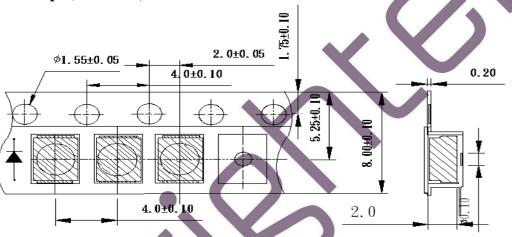
Feeding Direction



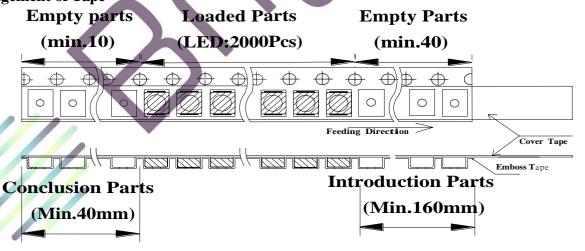
Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



• Arrangement of Tape



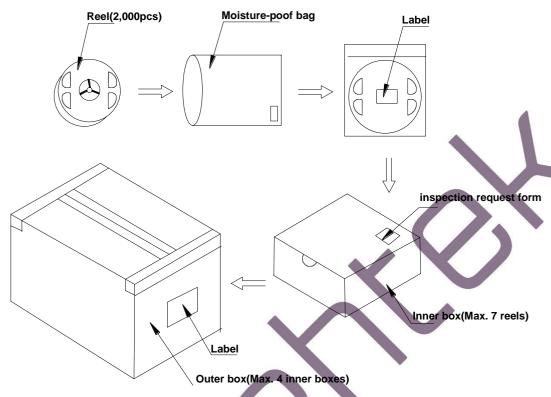
Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The max loss number of SMD is 2pcs
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications
- 4. 2,000pcs per reel



Packing

Packaging Specifications



Notes:

Reeled product (max.2,000pcs) is packed in a sealed moisture-proof bag. Seven bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.





Precautions

1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area



3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

4. This usage and handling instruction is only for your reference.



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■ Test Items and Results of Reliability

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Test Item	Test Conditions	Duration/ Cycle	Ac/Re	Number of Damage	Reference
Normal Temperature Life	$Ta = 23^{\circ}C(\pm 5^{\circ}C)$ $I_{F}=20\text{mA}$	1008 hrs	0/1	0/22	JESD22 A-108
High Temperature Life	$Ta = 85^{\circ}C(\pm 5^{\circ}C)$ $I_{F}=20\text{mA}$	1008 hrs	0/1	0/22	JESD22 A-108
High Humidity Heat Life	$Ta = 85^{\circ}C(\pm 5^{\circ}C)$) RH=85% $I_{E}=20$ m A	1008 hrs	0/1	0/22	JESD22 A-108
Thermal shock	-45°¢30min~105°¢ /30min (±5°¢	1008 hrs	0/1	0/22	JESD22 A-104
Electrostatic Discharge (ESD) Test	According to the SPEC	3 cycles	0/1	0/22	AEC Q101-001
Low Temperature Storage	T _a =-40°C	1008 hrs	0/1	0/22	JESD22-A103D
High Temperature Storage	T ₄ =125°C	1008 hrs	0/1	0/22	JESD22-A103D

*Criteria for Judging					
Item	Symbol	Condition	Criteria for Judgment of Pass		
Item	Symbol Conditio		Min	Max	
Forward Voltage	V_{F}	I _F =20mA	-	USL* ¹ ×1.1	
Reverse Current	I_R	$V_R = 10V$	-	10μΑ	
Luminous Intensity	Iv	I _F =20mA	LSL*2×0.7	-	

[Note] USL*1: Upper Specification Level

LSL*2: Lower Specification Level